

Appln No. 10/760,186
Amdt. Dated January 30, 2006
Response to Office Action of November 14, 2005

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Amendments to the Specification:

The paragraph beginning at page 9, line ⁵7 to line ⁶8 is to be amended as follows:

The ink jet printhead chip 52 (see Fig. 6) includes a silicon wafer substrate 8015. 0.35 Micron 1 P4M 12 volt CMOS microprocessing circuitry is positioned on the silicon wafer substrate 8015.